## Supporting Information

Direct Surface Modification of Poly(VDF-*co*-TrFE) Films by Surface-initiated ATRP without Pretreatment

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1. XPS depth profiling of poly(VDF-co-TrFE)-g-poly(tBA) film using C<sub>60</sub> sputtering.



Figure S1. Sputter depth profiling of  $C_{1s}$ ,  $O_{1s}$  and  $F_{1s}$  of poly(VDF-*co*-TrFE)-*g*-poly(*t*BA) by  $C_{60}^+$  sputtering. Atomic concentration of C, O, and F were normalized. The sputter rate was 83.3 nm/min.

XPS spectra were recorded on a PHI Quantera SXM (ULVAC-PHI, Chigasaki, Japan) system using a micro-focused (100  $\mu$ m, 24.8 W, 15kV) Al X-ray beam (1486.6 eV) with a photoelectron take-off angle of 45°. A dual-beam charge neutralizer (10 V - 7  $\mu$ A for Ar<sup>+</sup>, and 1.0 V - 20  $\mu$ A for electron beam) was used to compensate the charge-up effect. The C<sub>60</sub><sup>+</sup> ion source was operated at acceleration voltage of 10 kV with raster area of 2 mm × 2 mm. Analysis size on the sample was  $\phi$  0.1 mm. The base pressure of the main chamber (7.0 × 10<sup>-7</sup> Pa) was achieved by evacuation using turbomolecular and ion-getter pumps. The reference specimen for sputter rate measurement was poly(tBA) spin-coated film on Si wafer, of which thickness was determined by ellipsometer. The sputter rate by C<sub>60</sub><sup>+</sup> ion was determined to be

83.3 nm/min.

As shown in Figure S1, atomic concentration of oxygen gradually decreased and that of fluorine increased with sputtering time. The depth profiles of  $O_{1s}$  and  $F_{1s}$  indicated that the interface of poly(tBA) and poly(VDF-*co*-TrFE) was not sharp. Although the outermost surface was almost covered by poly(tBA), there was a mixture region of poly(tBA) and poly(VDF-*co*-TrFE) inside the film. If we determine the interface between poly(tBA) and poly(VDF-*co*-TrFE) to be the position when the normalized intensity of  $O_{1s}$  was 0.50, it took 0.32 min to achieve the interface by exposure to  $C_{60}^+$  beam. The thickness of surface-grafted poly(tBA) layer was estimated by sputter time and sputter rate to be 0.32 (min) × 83.3 (nm/min) = 26.6 (nm).

2. XPS spectra of  $C_{1s}$  region of poly(VDF-*co*-TrFE) and poly(VDF-*co*-TrFE)-*g*-poly(*t*BA) films



Figure S2. Narrow scan XPS spectra of  $C_{1s}$  region of (a) poly(VDF-*co*-TrFE) and (b) poly(VDF-*co*-TrFE)-*g*-poly(*t*BA) films

XPS measurement was carried out using an XPS-APEX (Physical Electronics Inc.) at  $1 \times 10^{-9}$  Pa using a monochromatic Al  $K_{\alpha}$  X-ray source operated at 200 W. XPS spectra were collected at takeoff angle of 45°. High-resolution spectra of the C<sub>1s</sub> were acquired at an energy step of 0.1 eV. Peak area ratio of C-F, C=O, C–O, and C–C bonds in Figure S2(b) was estimated by four Gaussian fitting curves, as represented in Table S1.

| -F C   | C=O                                | C-0  | C-C   |
|--------|------------------------------------|--|---|
| 1.0 28 | 39.09 2                            | 286.8  | 285.3   |
| .2 1   | 2.4                                | 23.9   | 60.5  |
| .0 1   | 11.1                               | 22.2   | 66.7  |
|        | 2-F C<br>11.0 28<br>2.2 1<br>0.0 1 | C-F C=O<br>01.0 289.09 2<br>0.2 12.4<br>0.0 11.1 | C-F C=O C-O<br>1.0 289.09 286.8 2<br>2.2 12.4 23.9<br>0.0 11.1 22.2 |

Table S1. Area ratio of C-F, C=O, C–O, and C–C bonds of Figure S2(b)

<sup>*a*</sup> Theoretical ratio of poly(*t*BA).